

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Dershem, et. al.

Title: THERMOSETTING RESIN
COMPOSITIONS CONTAINING
MALEIMIDE AND/OR VINYL
COMPOUNDS

Appl. No.: Unassigned

Filing Date: Herewith

Examiner: Unassigned

Art Unit: Unassigned

Commissioner for Patents
Washington, D.C. 20231

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PRELIMINARY AMENDMENT

Sir:

This Preliminary Amendment is being filed prior to examination of the above-identified Continuing Prosecution Application. Prior to examination of the above-identified application, please consider the following amendments and remarks.

IN THE CLAIMS

Please add new claims 46-48 and cancel claims 1-45.

46. A die-attach composition comprising a maleimide-containing curable component, wherein said composition is capable of curing at a temperature of less than about 200°C in a period of time of about 0.25 minutes up to about 2 minutes.